

TOSHIBA Power Transistor Module
Silicon PNP Triple Diffused Type (Four Darlingtons in One)

MP4009

High Power Switching Applications
Hammer Drive, Pulse Motor Drive
Inductive Load Switching

- Small package by full molding (SIP 10 pins)
- High collector power dissipation (4-device operation)
: $P_T = 4 \text{ W}$ ($T_a = 25^\circ\text{C}$)
- High collector current: $I_C \text{ (DC)} = -5 \text{ A}$ (max)
- High DC current gain: $h_{FE} = 1000$ (min) ($V_{CE} = -3 \text{ V}$, $I_C = -3 \text{ A}$)
- Complementary to MP4003

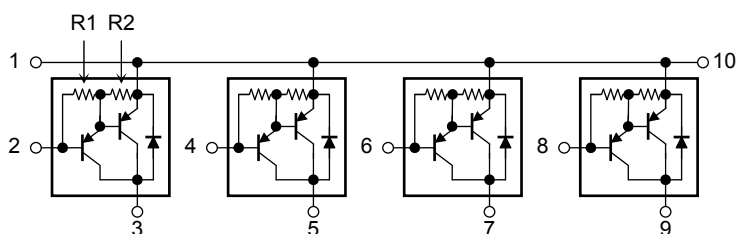
Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

| Characteristics | | Symbol | Rating | Unit |
|--|-------|-----------|------------|------------------|
| Collector-base voltage | | V_{CBO} | -100 | V |
| Collector-emitter voltage | | V_{CEO} | -100 | V |
| Emitter-base voltage | | V_{EBO} | -5 | V |
| Collector current | DC | I_C | -5 | A |
| | Pulse | I_{CP} | -8 | |
| Continuous base current | | I_B | -0.1 | A |
| Collector power dissipation (1 device operation) | | P_C | 2.0 | W |
| Collector power dissipation (4 devices operation) | | P_T | 4.0 | W |
| Junction temperature | | T_j | 150 | $^\circ\text{C}$ |
| Storage temperature range | | T_{stg} | -55 to 150 | $^\circ\text{C}$ |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

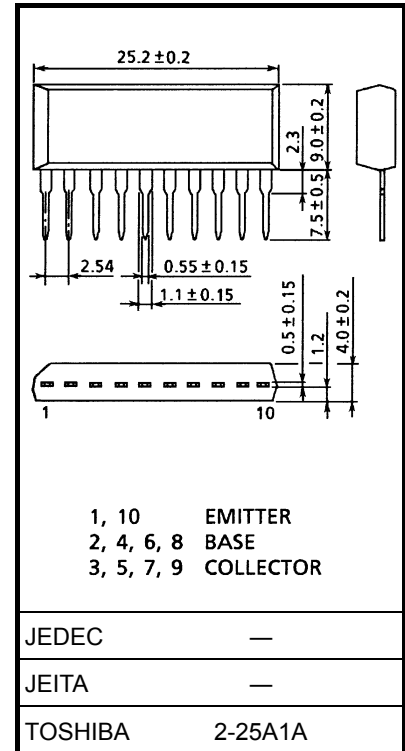
Array Configuration



$R1 \approx 5 \text{ k}\Omega$, $R2 \approx 120 \Omega$

Industrial Applications

Unit: mm

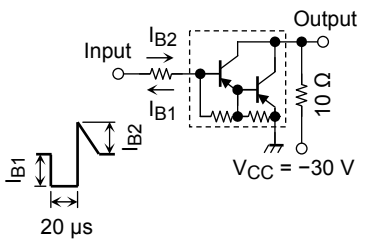


Weight: 2.1 g (typ.)

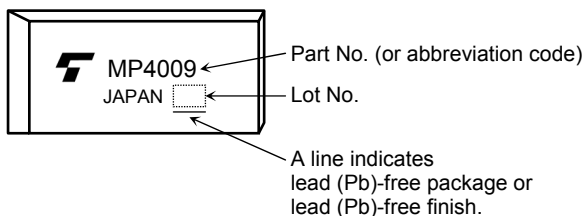
Thermal Characteristics

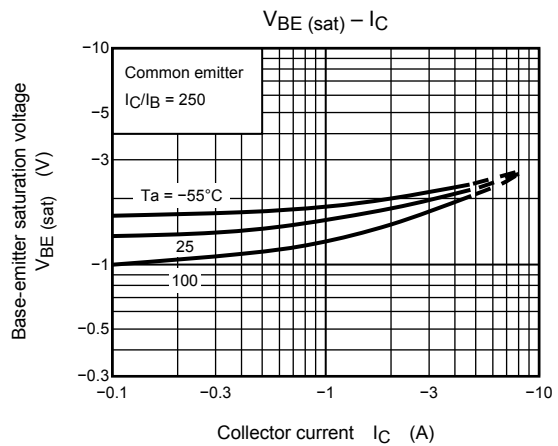
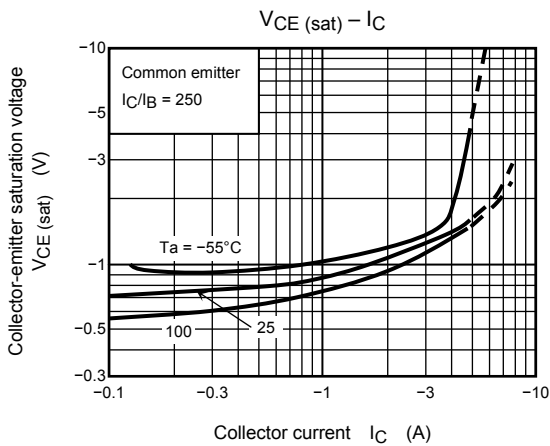
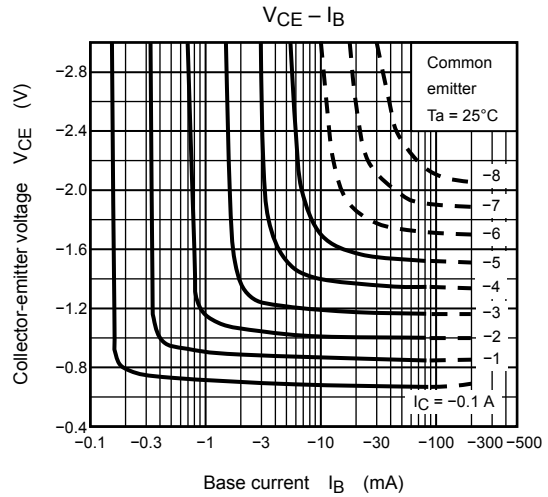
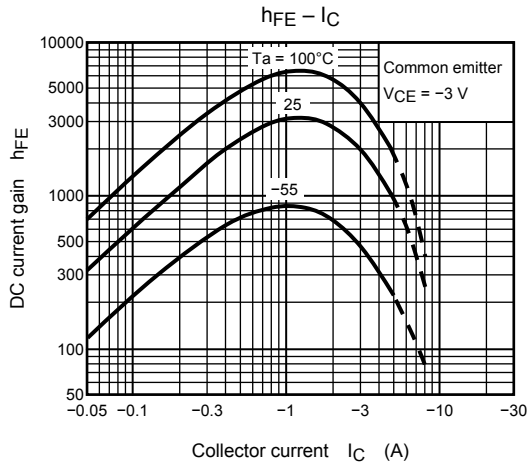
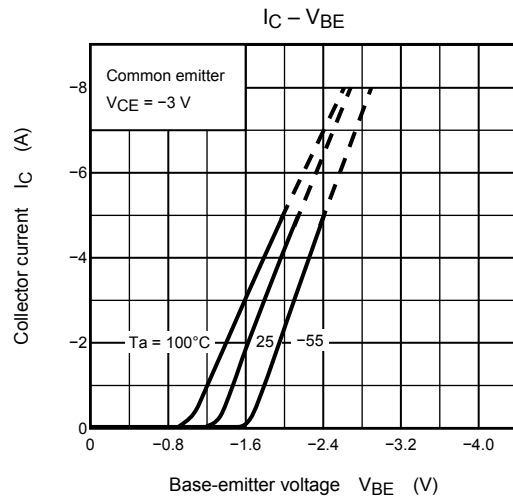
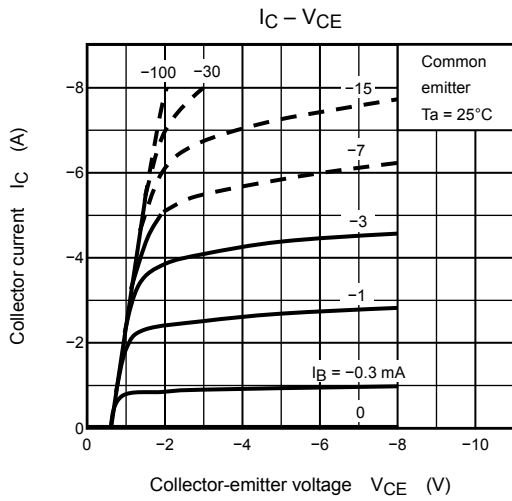
| Characteristics | Symbol | Max | Unit |
|--|----------------------|------|------|
| Thermal resistance from junction to ambient (4-device operation, Ta = 25°C) | $\Sigma R_{th(j-a)}$ | 31.3 | °C/W |
| Maximum lead temperature for soldering purposes (3.2 mm from case for 10 s) | T _L | 260 | °C |

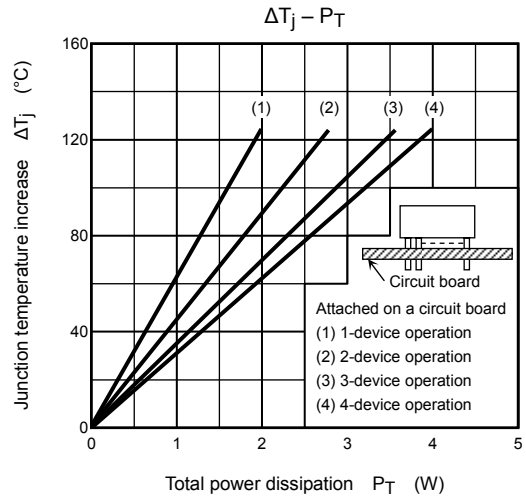
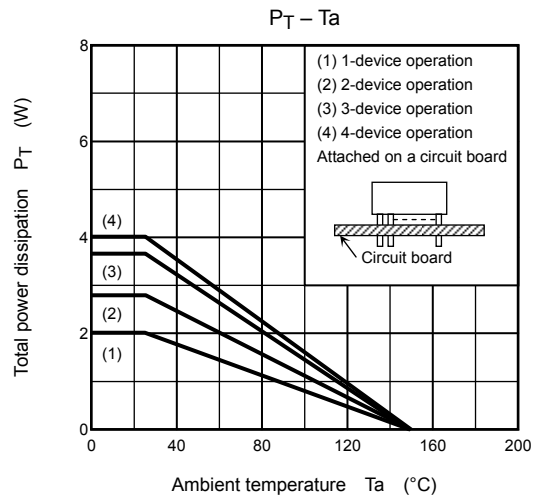
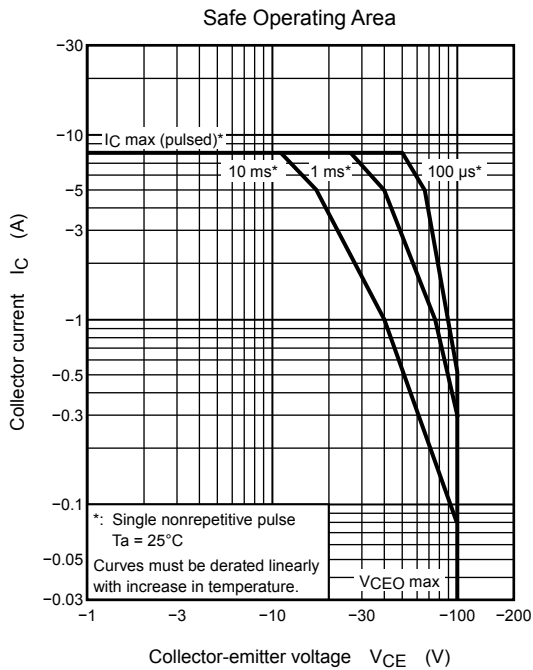
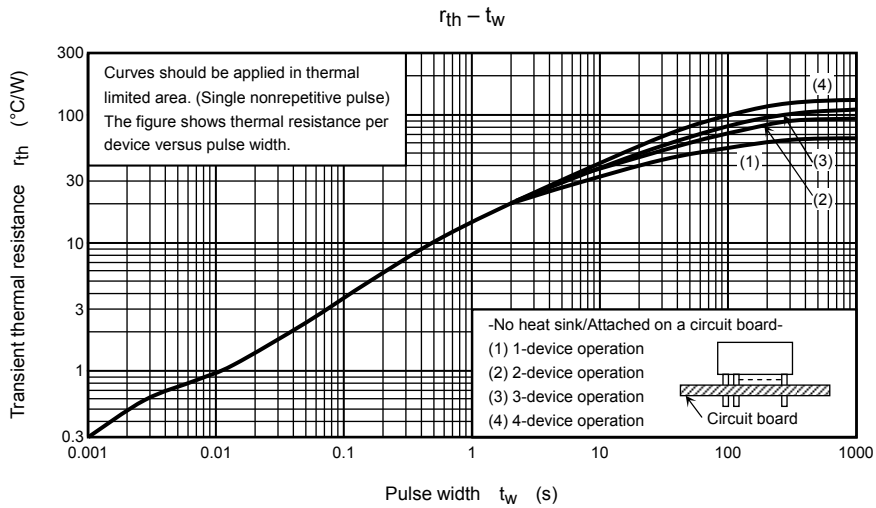
Electrical Characteristics (Ta = 25°C)

| Characteristics | | Symbol | Test Condition | Min | Typ. | Max | Unit |
|-------------------------------------|-------------------|-----------------------|--|------|------|------|------|
| Collector cut-off current | | I _{CBO} | V _{CB} = -100 V, I _E = 0 A | — | — | -10 | μA |
| Collector cut-off current | | I _{CEO} | V _{CE} = -100 V, I _B = 0 A | — | — | -10 | μA |
| Emitter cut-off current | | I _{EBO} | V _{EB} = -5 V, I _C = 0 A | -0.3 | — | -2.0 | mA |
| Collector-base breakdown voltage | | V _{(BR) CBO} | I _C = -1 mA, I _E = 0 A | -100 | — | — | V |
| Collector-emitter breakdown voltage | | V _{(BR) CEO} | I _C = -30 mA, I _B = 0 A | -100 | — | — | V |
| DC current gain | | h _{FE} (1) | V _{CE} = -3 V, I _C = -0.5 A | 1000 | — | — | — |
| | | h _{FE} (2) | V _{CE} = -3 V, I _C = -3 A | 1000 | — | — | |
| Saturation voltage | Collector-emitter | V _{CE(sat)} | I _C = -3 A, I _B = -12 mA | — | — | -2.0 | V |
| | Base-emitter | V _{BE(sat)} | I _C = -3 A, I _B = -12 mA | — | — | -2.5 | |
| Transition frequency | | f _T | V _{CE} = -3 V, I _C = -0.5 A | 3 | — | — | MHz |
| Collector output capacitance | | C _{ob} | V _{CB} = 50 V, I _E = 0 A, f = 1MHz | — | 40 | — | pF |
| Switching time | Turn-on time | t _{on} |  | — | 0.5 | — | μs |
| | Storage time | t _{stg} | | — | 3.0 | — | |
| | Fall time | t _f | | — | — | 2.0 | |
| | | | -I _{B1} = I _{B2} = 12 mA, duty cycle ≤ 1% | | | | |

Marking







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20070701-EN

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